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Part Number: 07	39447217	
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	M Backplane Connector System	With the states
Description: H	M Board-to-Board Backplane Header, Vertical, SMC ide Post Location A, Polarizing Key Position N/A, 14	
Documents:		
3D Model	Product Specification	PS-73670-9999-001 (PDF)
<u>3D Model (PDF)</u>		on PK-70873-0818-001 (PDF)
Drawing (PDF)	RoHS Certificate of Co	
	<u>Norio Certificate or O</u>	Series image - Reference only
Agency Certification		
CSA	LR19980	EU ELV
UL	E29179	Not Relevant
General		EU RoHS China RoHS
Product Family	Backplane Connectors	Compliant
Series	73944	REACH SVHC
Application	Backplane	Not Contained Per -
Component Type	PCB Header	D(2020)9139-DC (19
Overview	HDM Backplane Conne	-
Product Name	HDM	Halogen-Free
UPC	800754876568	<u>Status</u>
Dhusiaal		Low-Halogen
Physical	4.4.4	For more information, please visit Contact U
Circuits (Loaded)	144	
Circuits (maximum)	144 Diasia Natural	China ROHS Green Image
Color - Resin	Black, Natural	ELV Not Relevant
Durability (mating cycles n		RoHS Phthalates Not Contained
First Mate / Last Break	No	
Flammability	94V-0	
Guide to Mating Part	Yes	Search Parts in this Series
Keying to Mating Part	Yes	72044 Carias
Material - Metal	Phosphor Bronze, Stain	less Steel
Material - Plating Mating	Gold	Mates With
Material - Plating Terminal		
Material - Resin	High Temperature Then	moplastic <u>73632</u> HDM+ Board-to-Board Daughterca Receptacle. 73780 HDM Board-to-Board
Net Weight	8.594/g	Daughtercard Receptacle
Number of Columns	24 Open Die Field	
Number of Pairs	Open Pin Field	
Number of Rows	6 Martiaal	Application Tooling FAQ
Orientation	Vertical	Tooling specifications and manuals are
PC Tail Length	3.50mm	found by selecting the products below.
PCB Locator	Yes	Crimp Height Specifications are then
PCB Retention	None	contained in the Application Tooling
PCB Thickness - Recomm		Specification document.
Packaging Type	Tube	Global
Pitch - Mating Interface	2.00mm	Description Product #
Pitch - Termination Interfa		Extraction Tool 621001000
Plating min - Mating	0.762µm	
Plating min - Termination	2.540µm	
Polarized to PCB	No	
Stackable	No No	
Surface Mount Compatible		
Temperature Range - Ope		
Termination Interface: Sty	e Through Hole	

Electrical	
Current - Maximum per Contact	1.0A
Data Rate	1.0 Gbps
Shielded	No
Voltage - Maximum	250V AC
Solder Process Data	
Duration at Max. Process Temperature (seconds)	040
Lead-freeProcess Capability	SMC&WAVE
Max. Cycles at Max. Process Temperature	003
Process Temperature max. C	260
Material Info	
Reference - Drawing Numbers	
Packaging Specification	DK-70873-0818-

Packaging Specification Product Specification Sales Drawing

PK-70873-0818-001 PS-73670-9999-001 SD-73944-001-001, SD-73944-001-002

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